

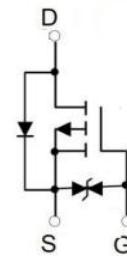


迈拓电子
MAITUO ELECTRONIC

MT3139K P-Channel MOSFET

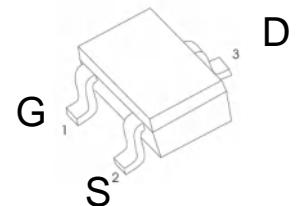
Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
-20V	510mΩ@-4.5V	-0.75A
	750mΩ@-2.5V	
	960mΩ(TYP)@-1.8V	



Feature

- Surface Mount Package
- P-Channel Switch with Low RDS(on)
- Operated at Low Logic Level Gate Drive



Application

- Load/Power Switching
- Interfacing, Logic Switching
- Battery Management for Ultra Small Portable Electronics

SOT-23

MARKING: 39K

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 8	V
Continuous Drain Current	I_D	-0.75	A
Pulsed Drain Current ⁽¹⁾	I_{DM}	-1.2	A
Power Dissipation ⁽²⁾	P_D	150	mW
Thermal Resistance from Junction to Ambient ⁽¹⁾	$R_{\theta JA}$	833	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C



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MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-20			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 8\text{V}, V_{\text{DS}} = 0\text{V}$			± 20	μA
Gate threshold voltage ⁽³⁾	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.35	-0.61	-1.1	V
Drain-source on-resistance ⁽³⁾	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_D = -1\text{A}$		420	510	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_D = -0.8\text{A}$		630	750	
		$V_{\text{GS}} = -1.8\text{V}, I_D = -0.5\text{A}$		960		
Forward transconductance	g_{FS}	$V_{\text{DS}} = -10\text{V}, I_D = -0.54\text{A}$	0.8			S
Dynamic characteristics⁽⁴⁾						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -16\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		113		pF
Output Capacitance	C_{oss}			15		
Reverse Transfer Capacitance	C_{rss}			9		
Switching Characteristics⁽⁴⁾						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DS}} = -10\text{V}, I_D = -200\text{mA}, V_{\text{GS}} = -4.5\text{V}, R_G = 10\Omega$		9		ns
Turn-on rise time	t_r			5.7		
Turn-off delay time	$t_{\text{d}(\text{off})}$			32.6		
Turn-off fall time	t_f			20.3		
Source-Drain Diode characteristics						
Diode forward voltage ⁽³⁾	V_{DS}	$I_S = -0.5\text{A}, V_{\text{GS}} = 0\text{V}$			-1.2	V

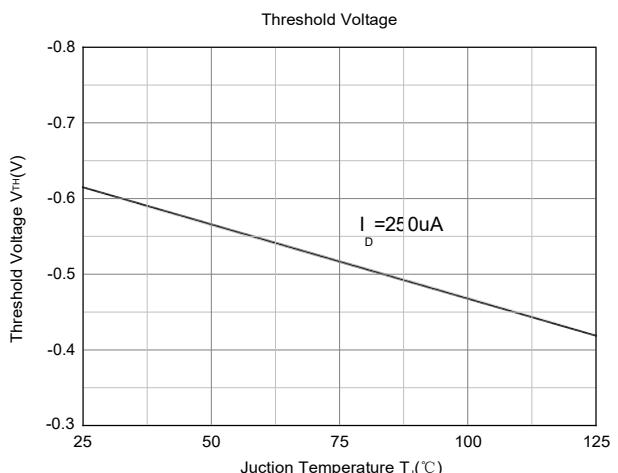
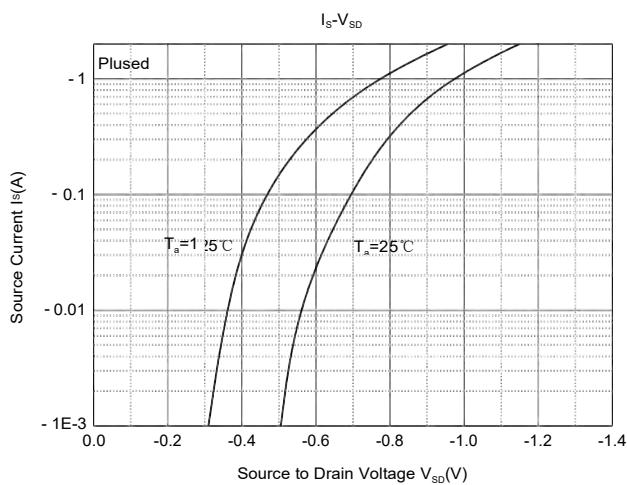
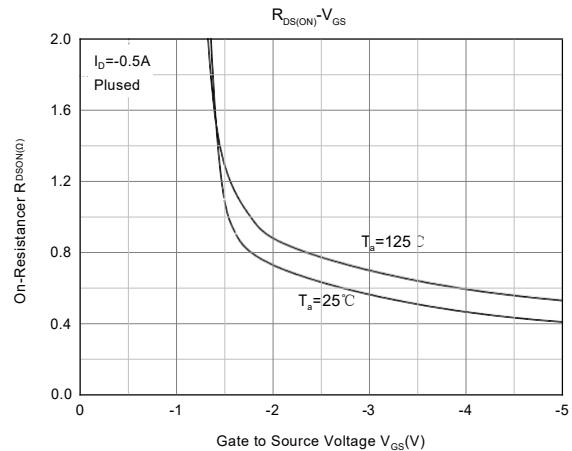
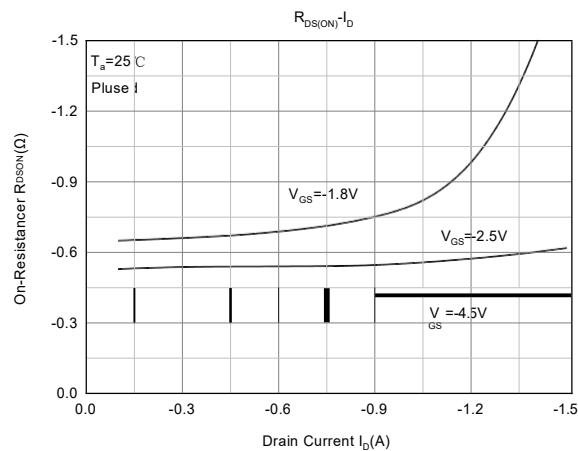
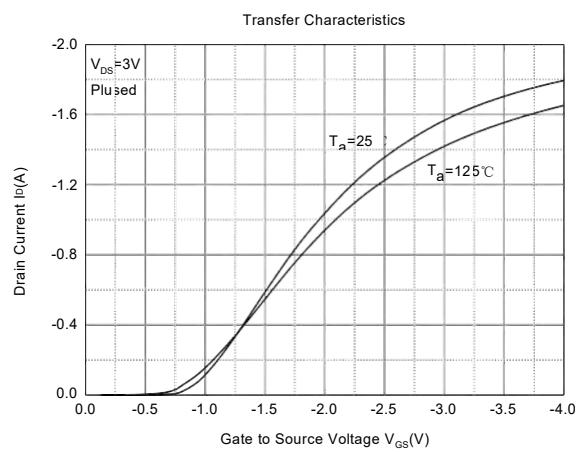
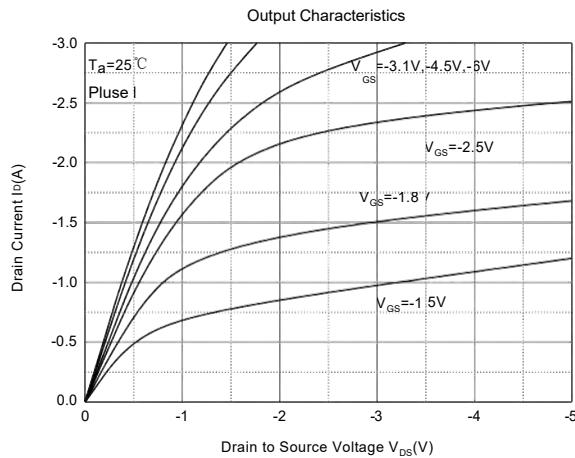
Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at $T_a=25^\circ\text{C}$.
3. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$.
4. These parameters have no way to verify.



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Typical Electrical and Thermal Characteristics



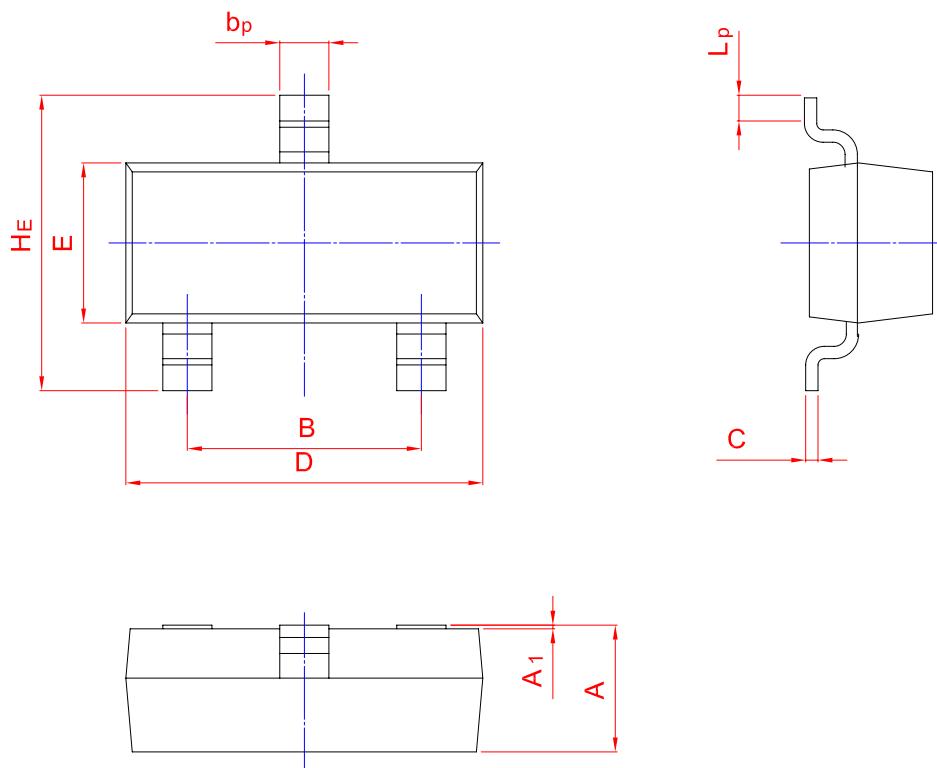


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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



UNIT	A	B	b_p	C	D	E	H_E	A_1	L_p
mm	1.40 0.95	2.04 1.78	0.50 0.35	0.19 0.08	3.10 2.70	1.65 1.20	3.00 2.20	0.100 0.013	0.50 0.20